



可控硅光耦
Photo Triac

MOC3053SM

Product Data Sheet

AOTE DCC
RELEASE

台湾奥特半导体科技有限公司

TAIWAN AOTE SEMICONDUCTOR TECHNOLOGY CO.,LTD

[www . aote se mi . co m](http://www.aotese mi .co m)

概述 Description

- MOC3053SM 器件是由一个 GaAs 红外发光二极管和一个单晶硅芯片的过零相位光电双向晶闸管组成的光电耦合器。

The MOC3053SM series devices are optocouplers composed of a GaAs infrared light emitting diode and a single -crystal silicon chip random phase photoelectric bidirectional thyristor.

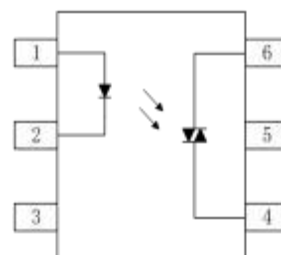
特性 Features

- 峰值击穿电压
Peak breakdown voltage
600V : MOC305X ;
- 输入-输出隔离电压 ($V_{ISO} = 5000 \text{ Vrms}$)
High isolation voltage between input and output($V_{ISO} = 5000 \text{ Vrms}$)
- 工作温度 : $-55^{\circ}\text{C} \sim 110^{\circ}\text{C}$
Operating Temperature: $-55^{\circ}\text{C} \sim 110^{\circ}\text{C}$
- 符合加强绝缘标准
Meet reinforced insulation standards
- 符合安规标准 : UL 1577 , VDE DIN EN60747-5-5 (VDE 0884-5) , CQC11-471543-2022
Safety standard approval: UL 1577, VDE DIN EN60747-5-5 (VDE 0884-5) , CQC11-471543-2022

应用 Applications

- 开关电源 , 智能电表
Switching power supply, intelligent meter
- 工业控制 , 测量仪器
Industrial control, measuring instruments
- 办公设备 , 比如复印机
Office equipment such as copiers
- 家用电器 , 比如空调、风扇、热水器等
Household appliances: such as air conditioners, fans, water heaters, etc.

封装和原理图 packageandschematic Diagram



Pin Configuration

1. Anode
2. Cathode
3. NC
4. GND
5. NC
6. VCC

印字信息 Marking Information

- 印字中 “” 为奥特品牌 LOGO
“” denotes LOGO
- 印字中 “Y” 代表年份； A(2018),B(2019),C(2020)
“Y” denotes YEAR： A(2018), B(2019), C(2020)
- 印字中 “WW” 代表周号
“WW” denotes Week’ s number
- 印字中 “E” 代表内部代码
“E” denotes Internal code
- 印字中的 “H” 代表无卤
“H” denotes Halogen-free



绝缘和安规信息 Insulation and safety related specifications

项目 Item	符号 Symbol	数值 Value	单位 Unit	备注 Remark
爬电距离 Creepage Distance	L	>7.0	mm	从输入端到输出端，沿本体最短距离路径 Measured from input terminals to output terminals, shortest distance path along body
电气间隙 Clearance Distance	L	>7.0	mm	从输入端到输出端，通过空气的最短距离 Measured from input terminals to output terminals, shortest distance through air
绝缘距离 Insulation Thickness	DTI	>0.4	mm	发射器和探测器之间的绝缘厚度 Insulation thickness between emitter and detector
峰值隔离电压 Peak Isolation Voltage	V _{IORM}	1500	V _{peak}	DIN/EN/IEC EN60747-5-5
瞬态隔离电压 Transient isolation voltage	V _{IOTM}	7000	V _{peak}	DIN/EN/IEC EN60747-5-5
隔离电压 Isolation Voltage	V _{iso}	>5000	V _{rms}	For 1 min

极限参数 Absolute Maximum Ratings (Ta = 25°C)

参数 Parameter			符号 Symbol	额定值 Rating	单位 Unit
发射端 Input	正向电流 Forward Current		I _F	60	mA
	反向电压 Backward Voltage		V _R	6	V
	功耗 Power Dissipation		P _D	100	mW
	额定值降低因子(在 Ta = 90℃ 以上) Power dissipation Derating factor (above Ta = 90℃)		P _{DD}	3.8	mW/℃
接收端 output	断态输出端电压 Off-state output terminal voltage	MOC301X	V _{DRM}	250	V
		MOC302X		400	
		MOC305X		600	
	峰值重复浪涌电流(pw=100μs,120pps) Peak repetitive surge current (pw=100μs,120pps)		I _{TSM}	1	A
	开启态电流 (均方根值) On-state current (root mean square value)		I _{T(RMS)}	100	mA
	功耗 Power Dissipation		P _C	300	mW
	额定值降低因子(在 Ta = 85℃ 以上) Power dissipation Derating factor (above Ta = 90℃)			7.4	mW/℃
总功耗 Total Power Dissipation			P _{tot}	330	mW
工作温度 Operating Temperature			T _{opr}	-55~110	℃

参数 Parameter	符号 Symbol	额定值 Rating	单位 Unit
存储温度 Storage Temperature	T_{stg}	-55 ~125	°C
焊接温度 Soldering Temperature	T_{sol}	260	°C

*在相对湿度 40% ~ 60%下的进行交流电测试，此时 1、2 和 3 脚短接，4、5 和 6 脚短接。

* Conduct ACtest at 40% ~60% relative humidity. At this time, pins 1, 2 and 3 are short-circuited, and pins 4, 5 and 6 are short-circuited.

产品特性参数 Electro-optical characteristics (Ta=25°C)

参数 Parameter			符号 Symbol	条件 Condition	最小 Min.	典型 Typ.	最大 Max.	单位 Unit
发射端 Input	正向电压 Forward Voltage		V _F	I _F = 20mA	-	1.23	1.5	V
	反向电流 Back current		I _R	V _R = 6V	-	-	10	uA
接收端 Output	断态峰值电流 Off-state peak current		I _{DRM}	V _{DRM} = Rated V _{DRM} I _F = 0mA	-	-	100	nA
	通态峰值电压 On-state peak voltage		V _{TM}	I _{TM} = 100mA peak I _F = Rated I _{FT}	-	-	2.5	V
	断态电压临界上升率 Critical rise rate of off-state voltage	MOC301X	dv/dt	V _{PEAK} = Rated V _{DRM} I _F = 0	-	100	-	V/μs
		MOC302X			-	-	-	
		MOC305X		V _{PEAK} = 400V, I _F = 0	1000	-	-	
传输特性 Transfer Characteristics	LED 触发电流 LED trigger current	MOC3020	I _{FT}	主端电压 Main terminal Voltage = 3V	-	-	30	mA
		MOC3011			-	-	-	
		MOC3021			-	-	15	
		MOC3053			-	-	-	
		MOC3012			-	-	10	
		MOC3022			-	-	-	
		MOC3052			-	-	-	
		MOC3013			-	-	-	
		MOC3023			-	-	5	
		MOC3053			-	-	-	
	维持电流 Maintain current		I _H	-	-	250	-	uA

典型光电特性曲线 Typical Electro-optical characteristics curves

Fig.1 LED forward current vs Forward voltage

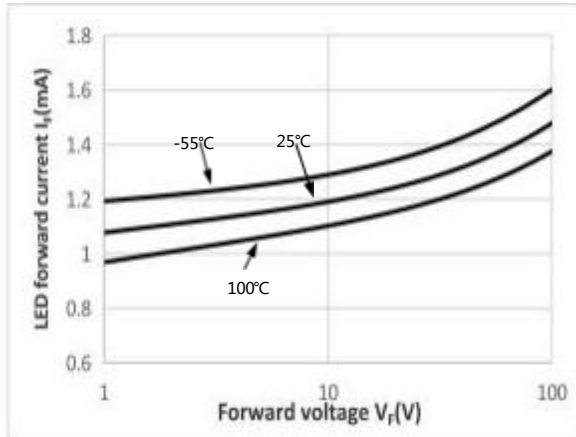


Fig.2 On-state characteristic diagram

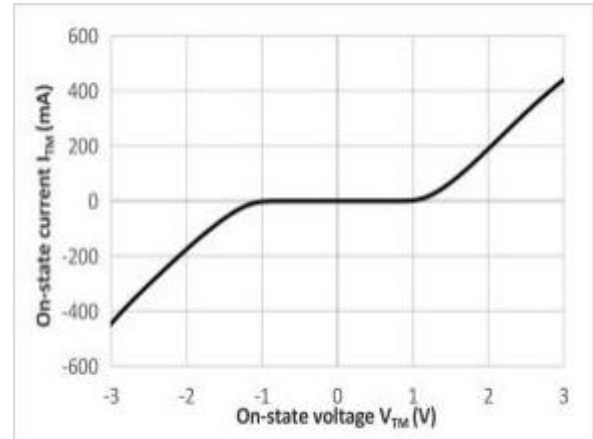


Fig.3 Trigger current vs Ambient temperature

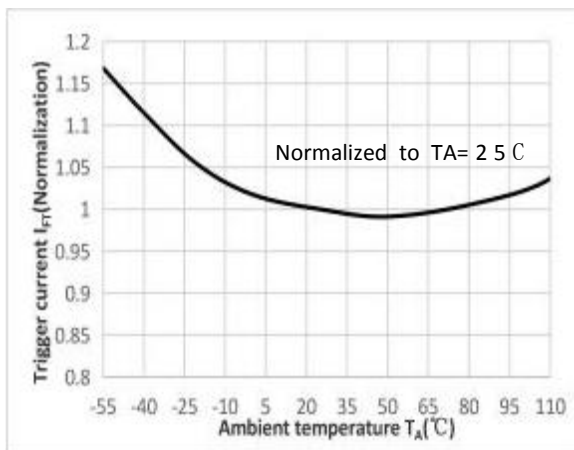


Fig.4 Trigger current vs LED pulse width

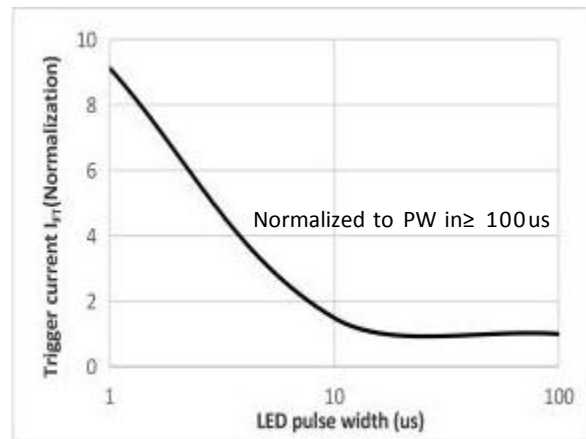


Fig.5 Maintenance current vs Ambient temperature

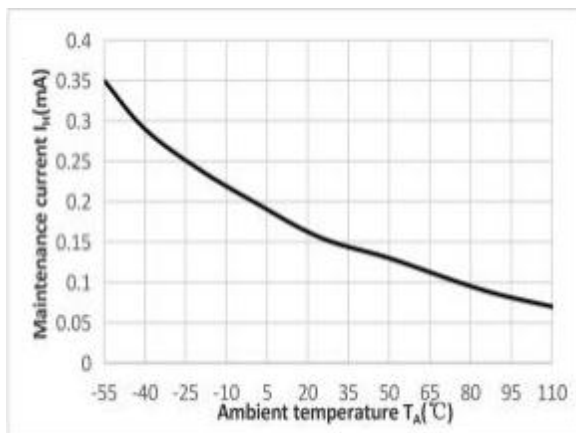


Fig.6 Leakage current vs Ambient temperature

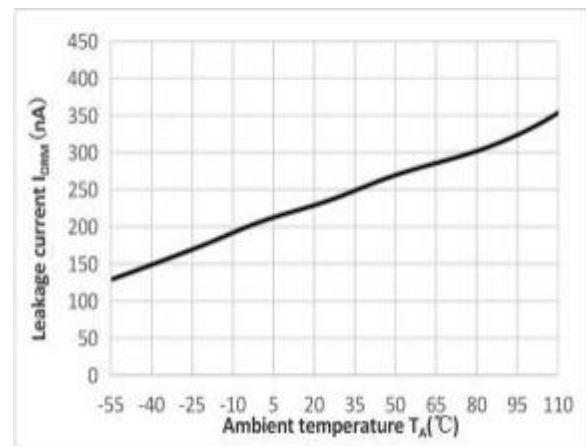
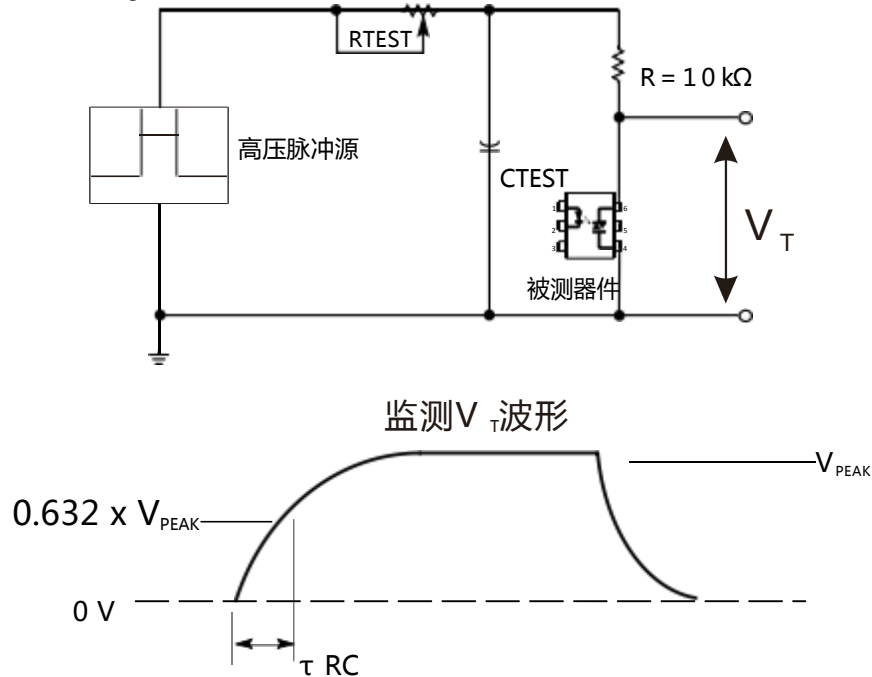


Fig.7 静态 dv/dt 测试电路和波形 Static dv/dt test circuit and waveform



通过 RC 电路施加于被测器件的输出端的高电压脉冲设置到所需的 V_{PEAK} 值上。LED 电流无需加上。波形 V_T 使用 X100 探头监测。通过调节 R_{TEST} 值， dv/dt (斜度) 增加，直到被测器件观察到被触发 (波形崩溃)。 dv/dt 然后下降，直到被测器件停止被触发。此时，记录 τ_{RC} 值并可计算 dv/dt 了。

The high voltage pulse applied to the output end of the device under test through the RC circuit is set to the desired V_{PEAK} value. LED current does not need to be added. Waveform V_T is monitored with X100 probe. By adjusting the R_{TEST} value, dv/dt (slope) increases until the device under test is observed to be triggered (waveform collapse). Dv/dt then drops until the device under test stops being triggered. At this time, dv/dt can be calculated by recording the value of τ_{RC} .

$$dv/dt = \frac{0.632 \times 400}{\tau_{RC}} = \frac{252}{\tau_{RC}}$$

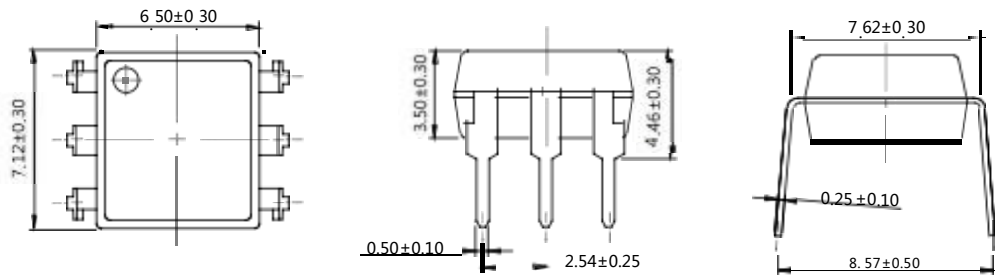
例如，AT302X 系列的电压峰值 = 400V。 dv/dt 值的计算方式如下：

For example, the voltage peak of AT304X series $V_{PEAK}=400V$. Then the dv/dt value can be calculated as follows：

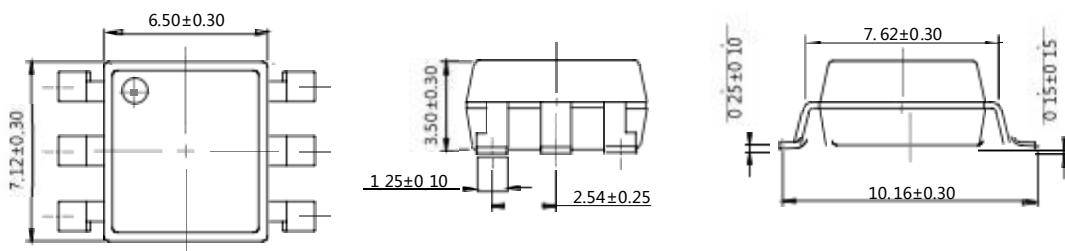
$$dv/dt = \frac{0.632 \times 400}{\tau_{RC}} = \frac{252}{\tau_{RC}}$$

外形尺寸Outline Dimensions

DIP6

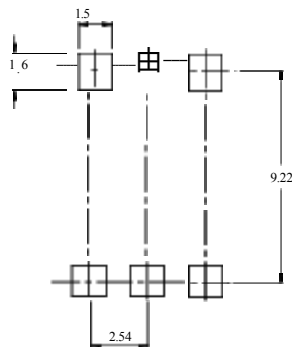


SMD6



单位 Unit: mm

建议焊盘布局 Recommended pad Layout

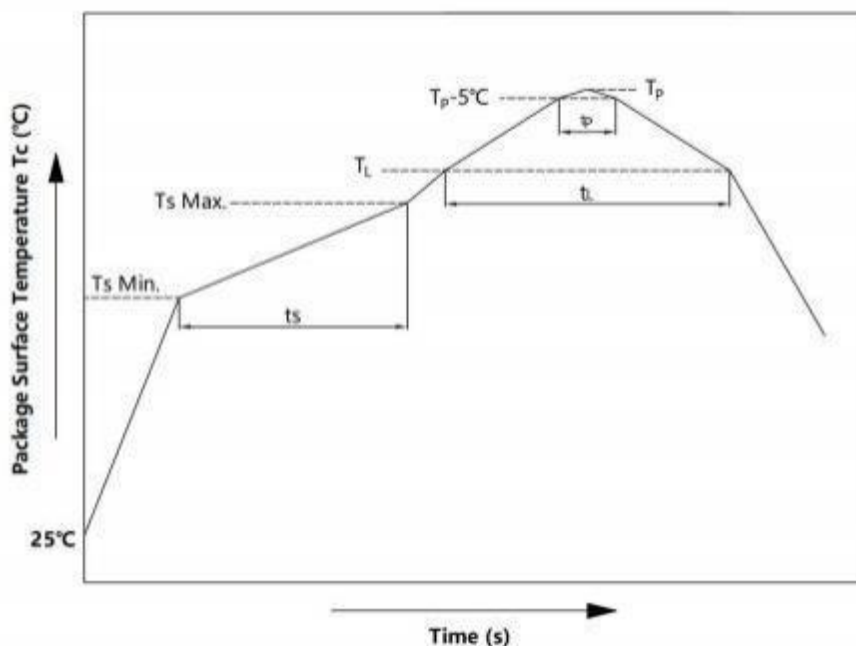


单位 Unit: mm

注：上图为产品正视图。

Note: The picture above is the front view of the product.

回流焊温度曲线图 solder Reflow profile



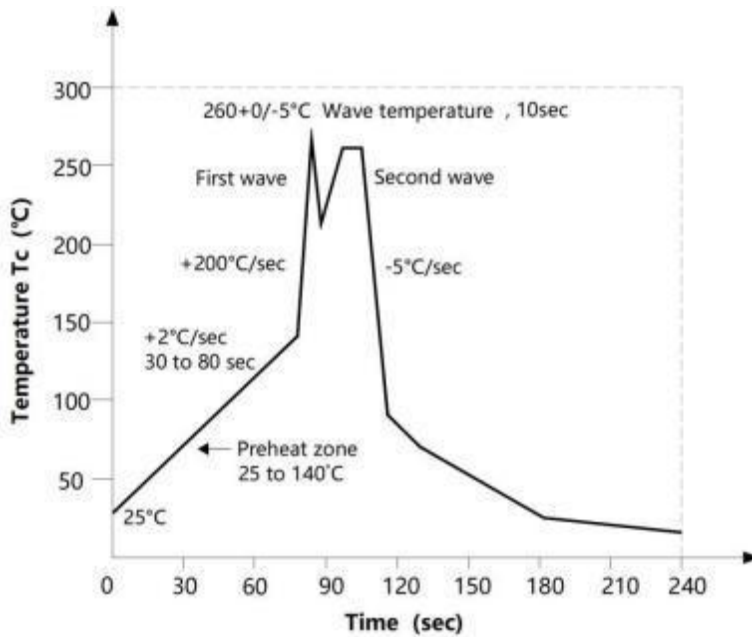
项目 Item	符号 Symbol	最小值 Min.	最大值 Max	单位 Unit
预热温度 Preheat Temperature	Ts	150	200	°C
预热时间 Preheat Time	ts	60	120	s
升温速率 Ramp-Up Rate (T _L to T _P)	-	-	3	°C/s
液相线温度 Liquidus Temperature	T _L	217		°C
时间高于 T _L Time Above T _L	t _L	60	150	s
峰值温度 Peak Temperature	T _P	-	260	°C
T _c 在(T _P -5)和 T _P 之间的时间 Time During Which T _c Is Between (T _P -5) and T _P	t _p	-	30	s
降温速率 Ramp-down Rate(T _P to T _L)	-	-	6	°C/s

注 Note :

建议在所示的温度和时间条件下进行回流焊 , 最多不能超过三次 ;

Reflow soldering is recommended at the temperatures and times shown, no more than three times;

波峰焊温度曲线图 wavesoldering profile



手工烙铁焊接 solderingwith handsolderingiron

- A. 手工烙铁焊仅用于产品返修或样品测试；
Hand soldering iron is only used for product rework or sample testing;
- B. 手工烙铁焊要求：温度 $360^{\circ}\text{C} \pm 5^{\circ}\text{C}$ ，时间 $\leq 3\text{s}$ 。
Hand soldering iron requirements：Temperature： $360^{\circ}\text{C} \pm 5^{\circ}\text{C}$, within 3s

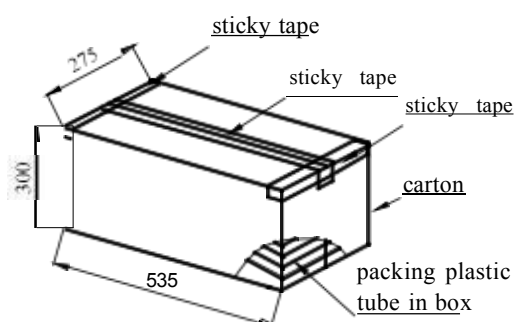
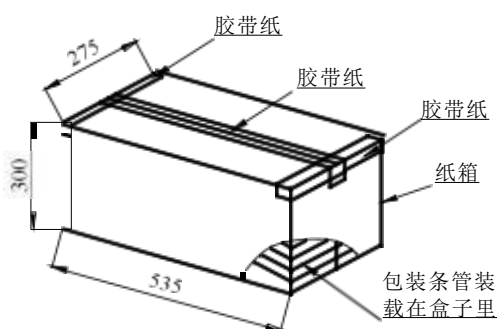
包装 packing

■ 汇总表summarytable

封装形式	包装方式	盘数量	盒数量	箱数量	静电袋规格	盒规格	箱(双瓦楞)规格	备注
DIP6	管装 (500*12*11mm)	65 只/管	50 管/盒	10 盒/箱	不适用	525*128*56mm	535*275*300mm	每管使用蓝白胶塞，方向须一致
SMD6	卷盘 (φ330mm蓝盘)	1000/盘	2 盘/盒	10 盒/箱	450*390*0.1mm	340*60*340mm	380*360*365mm	首尾端空至少200mm
Package Type	Packing Form	Quantity per Reel	Quantity per Box	Quantity per Carton	Antistatic Bag Specification	Box Specification	Carton Specification	Note
DIP6	Tube (500*12*11mm)	65 pcs /Tube	50 Tubes /box	10 boxes /ctn	Not applicable	525*128*56mm	535*275*300mm	Use blue and white rubber stoppers for each tube, with the same direction
SMD6	Reel (φ330mm Blue)	1k pcs/reel	2 reels /box	10 boxes /ctn	450*390*0.1mm	340*60*340mm	380*360*365mm	Leave at least 200mm of blank space at both ends

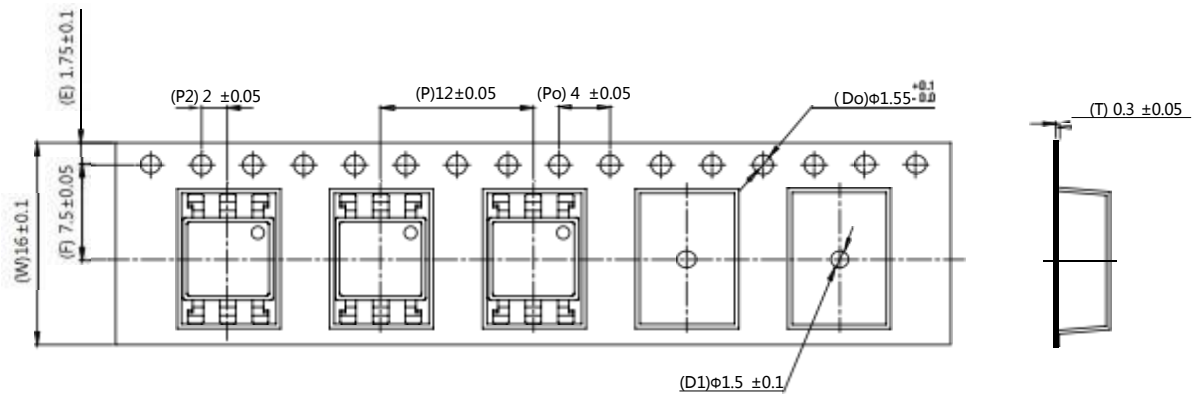
■ 管条包装Tape&Tube

- 1) 每管数量：65 只。
Qty/Tube：65 pcs.
- 2) 每箱数量：32500 只。
Qty/ctn：32500 pcs.
- 3) 内包装：每盒 50 管。
Inner packing：50 Tube/box.
- 4) 示意图 Schematic：



■ 编带包装Tape&Reel

- 1) 每卷数量：1000 只。
Qty/reel：1000 pcs.
- 2) 每箱数量：20000 只。
Qty/ctn：20000 pcs.
- 3) 内包装：每盒 2 盘。
Inner packing：2 reels/box.
- 4) 示意图 Schematic：



单位 Unit：mm

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